

GaAs INTEGRATED CIRCUIT μ PG2250T5N

1.8 TO 3.5 V POWER AMPLIFIER FOR BLUETOOTH™, ZIGBEE AND 2.4 GHz ISM BAND

DESCRIPTION

The $\mu PG2250T5N$ is a GaAs MMIC power amplifier developed for Bluetooth Class 1, ZigBee and 2.4 GHz ISM Band.

This device delivers high efficiency, high gain and high output power.

This device is housed in a 6-pin plastic TSON (\underline{T} hin \underline{S} mall \underline{O} ut-line \underline{N} on-leaded) package, and is suitable for high-density surface mounting.

FEATURES

Operating frequency : f_{opt} = 2 400 to 2 500 MHz (2 450 MHz TYP.)
 Supply voltage : V_{DD}1, 2, 3 = 1.5 to 3.5 V (1.8 V TYP.)
 Control voltage : V_{cont} = 1.5 to 2.1 V (1.8 V TYP.)

• Circuit current : IDD = 100 mA TYP. @ VDD1, 2, 3 = 1.8 V, Vcont = 1.8 V, Pout = +19 dBm

: IDD = 170 mA TYP. @ VDD1, 2, 3 = 3.0 V, Vcont = 1.8 V, Pout = +24 dBm

Output power
 : Pout = +20.0 dBm TYP. @ Vpd1, 2, 3 = 1.8 V, Vcont = 1.8 V, Pin = −5 dBm

: Pout = +25.0 dBm TYP. @ VDD1, 2, 3 = 3.0 V, Vcont = 1.8 V, Pin = -5 dBm

• Gain control range : GCR = 60 dB TYP. @ $V_{DD}1$, 2, 3 = 1.8 V, V_{cont} = 0 to 1.8 V, P_{in} = -5 dBm

High efficiency
 PAE = 55% TYP. @ VDD1, 2, 3 = 1.8 V, Vcont = 1.8 V, Pin = -5 dBm

• High-density surface mounting: 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)

APPLICATIONS

- · Power Amplifier for Bluetooth Class 1
- · ZigBee Range Extender
- General 2.4GHz ISM Band PA Applications

ORDERING INFORMATION

Part Numbe	r	Order Number	Package	Marking	Supplying Form
μPG2250T5N-	E2	μPG2250T5N-E2-A	6-pin plastic TSON (Pb-Free)	G5C	Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: $\mu PG2250T5N-A$

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

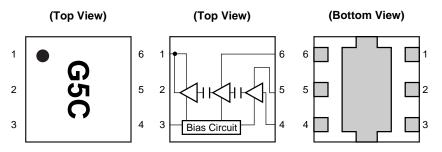
Document No. PG10639EJ03V0DS (3rd edition) Date Published February 2008 NS

The mark <R> shows major revised points.

© NEC Electronics Corporation 2006, 2008

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT/V _{DD} 3
2	N.C.
3	Vcont
4	INPUT
5	V _{DD} 1
6	V _{DD} 2

Remark Exposed pad : GND

ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD} 1, 2, 3	5.0	V
Control Voltage	V _{cont}	2.4	V
Circuit Current	IDD	250	mA
Control Current	Icont	5	mA
Input Power	Pin	+5	dBm
Power Dissipation	P□	400 Note	mW
Operating Ambient Temperature	TA	-40 to +85	°C
Storage Temperature	Tstg	−55 to +150	°C

Note Mounted on double-sided copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB, $T_A = +85^{\circ}C$

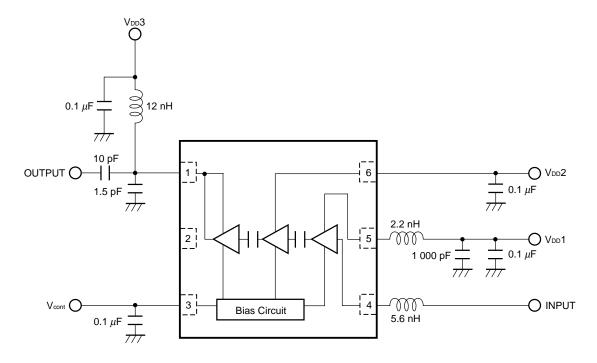
RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f _{opt}	2 400	2 450	2 500	MHz
Supply Voltage	V _{DD} 1, 2, 3	1.5	1.8	3.5	V
Control Voltage	V _{cont}	1.5	1.8	2.1	V

ELECTRICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, $V_{DD}1$, 2, 3 = 1.8 V, $V_{cont} = 1.8$ V, f = 2 450 MHz, external input and output matching, unless otherwise specified)

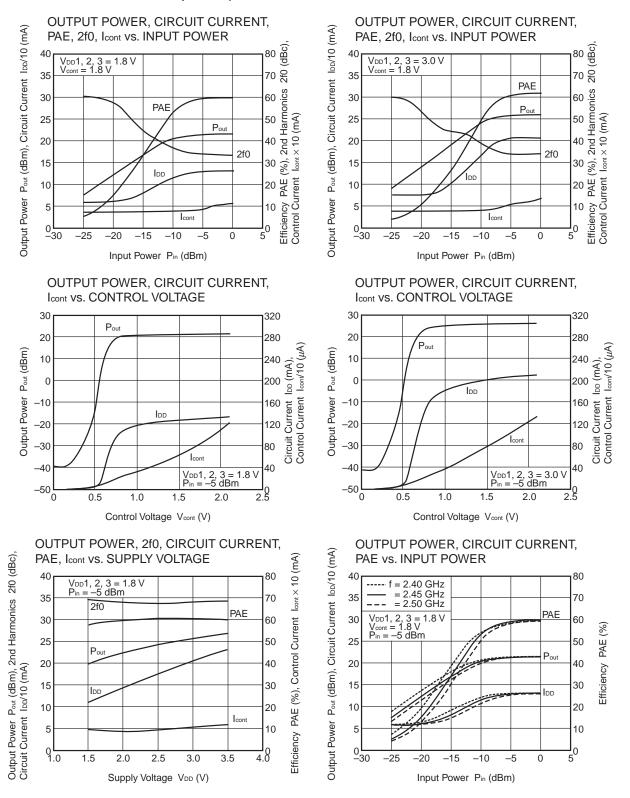
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	IDD	Pout = +19 dBm	-	100	130	mA
		V _{DD} 1,2,3 = 3.0 V, P _{out} = +24 dBm	_	170	-	mA
Control Current	Icont	Pout = +19 dBm	-	-	3	mA
Shut Down Current	shut down	V _{cont} = 0 V, RF None	_	-	5	μА
Output Power 1	Pout1	$P_{in} = -5 \text{ dBm}$	+19	+20	-	dBm
		$V_{DD}1,2,3 = 3.0 \text{ V}, P_{in} = -5 \text{ dBm}$	_	+25	-	dBm
Output Power 2	Pout2	V _{cont} = 0 V, P _{in} = -5 dBm	-	-40	-	dBm
Gain Control Range	GCR	V _{cont} = 0 to 1.8 V, P _{in} = -5 dBm	-	60	-	dB
Efficiency	PAE	Pin = -5 dBm	_	55	-	%
2nd Harmonics	2f0	Pin = -5 dBm	-	35	_	dBc

EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

TYPICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, f = 2450 MHz, with external input and output matching circuits, unless otherwise specified)

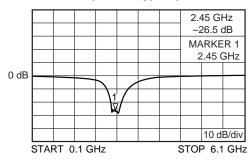


Remark The graphs indicate nominal characteristics.

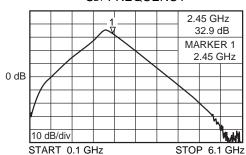
S-PARAMETERS 1

Condition : f = 0.1 to 6.1 GHz, $P_{in} = -30$ dBm, $V_{cont} = 1.8$ V, $V_{DD}1 = V_{DD}2 = V_{DD}3 = 1.8$ V

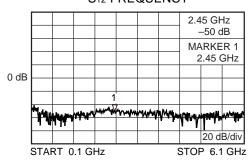
S₁₁-FREQUENCY



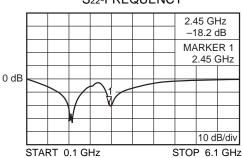
S₂₁-FREQUENCY



S₁₂-FREQUENCY



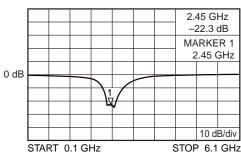
S22-FREQUENCY



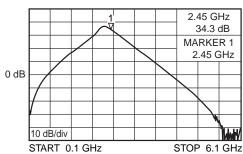
S-PARAMETERS 2

Condition : f = 0.1 to 6.1 GHz, $P_{in} = -30$ dBm, $V_{cont} = 1.8$ V, $V_{DD}1 = V_{DD}2 = V_{DD}3 = 3.0$ V

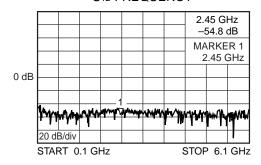
S₁₁-FREQUENCY



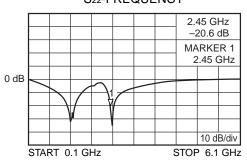
S₂₁-FREQUENCY



S₁₂-FREQUENCY



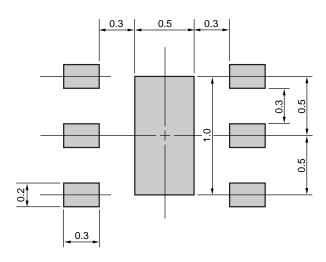
S22-FREQUENCY



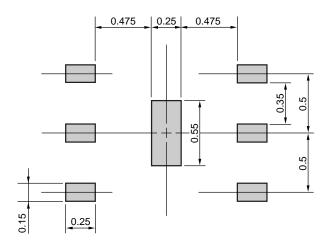
Remark The graphs indicate nominal characteristics.

MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS 6-PIN PLASTIC TSON (UNIT: mm)

MOUNTING PAD



SOLDER MASK

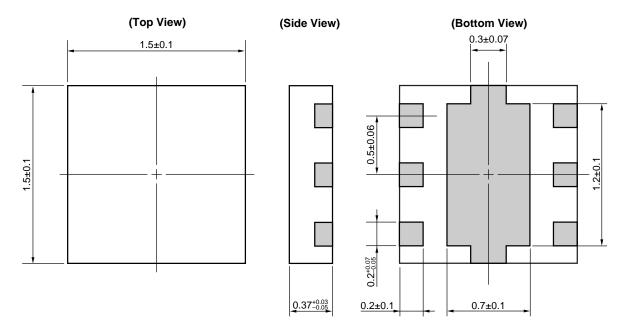


Solder thickness: 0.08 mm

Remark The mounting pad and solder mask layouts in this document are for reference only.

<R> PACKAGE DIMENSIONS

6-PIN PLASTIC TSON (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

Bluetooth is a trademark owned by Bluetooth SIG, Inc., U.S.A.

- The information in this document is current as of February, 2008. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without the prior
 written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may
 appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual
 property rights of third parties by or arising from the use of NEC Electronics products listed in this document
 or any other liability arising from the use of such products. No license, express, implied or otherwise, is
 granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software and information in the design of a customer's equipment shall be done under the full responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".
 - The "Specific" quality grade applies only to NEC Electronics products developed based on a customerdesignated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.
 - "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.